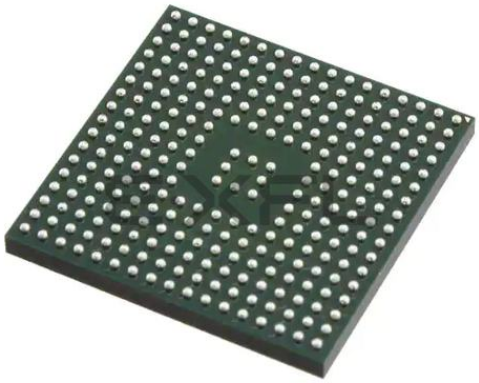

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Understanding Embedded - Microprocessors

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

Applications of Embedded - Microprocessors

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details	
Product Status	Last Time Buy
Core Processor	ARM920T
Number of Cores/Bus Width	1 Core, 32-Bit
Speed	200MHz
Co-Processors/DSP	Math Engine; MaverickCrunch™
RAM Controllers	SDRAM
Graphics Acceleration	Yes
Display & Interface Controllers	Keypad, LCD, Touchscreen
Ethernet	1/10/100Mbps (1)
SATA	-
USB	USB 2.0 (3)
Voltage - I/O	1.8V, 3.3V
Operating Temperature	0°C ~ 70°C (TA)
Security Features	Hardware ID
Package / Case	272-LFBGA
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/cirrus-logic/ep9307-crzr

OVERVIEW

The EP9307 is an ARM920T-based system-on-a-chip (SOC) design with a large peripheral set targeted to a variety of applications:

- Thin client computers for business and home
- Internet radio
- Internet access devices
- Industrial computers
- Specialized terminals
- Point of sale terminals
- Test and measurement equipment

The ARM920T microprocessor core with separate 16-kbyte, 64-way set-associative instruction and data caches is augmented by the MaverickCrunch™ co-processor, enabling high-speed floating point calculations.

MaverickKey™ unique hardware programmed IDs are a solution to the growing concern over secure web content and commerce. With Internet security playing an important role in the delivery of digital media such as books or music, traditional software methods are quickly becoming unreliable. The MaverickKey unique IDs provide OEMs with a method of utilizing specific hardware IDs such as those assigned for SDMI (Secure Digital Music Initiative) or any other authentication mechanism.

A high-performance 1/10/100 Mbps Ethernet media access controller (MAC) is included along with external interfaces to SPI, I^2S audio, Raster/LCD, keypad and touchscreen. A three-port USB 2.0 Full-speed Host (OHCI) (12 Mbits per second) and three UARTs are included as well.

The EP9307 is a high-performance, low-power, RISC-based, single-chip computer built around an ARM920T microprocessor core with a maximum operating clock rate of 200 MHz (184 MHz for industrial conditions). The ARM core operates from a 1.8 V supply, while the I/O operates at 3.3 V with power usage between 100 mW and 750 mW (dependent on speed).

Table A. Change History

Revision	Date	Changes
PP1	July 2004	Initial Release.
PP2	August 2004	Correct error in pin out table, pages 42 & 43.
PP3	August 2004	Minor correction.
PP4	March 2005	Update electrical characteristics with most-current characterization data.
F1	February 2010	Removed “Preliminary Data” statement from legal disclaimer. Removed lead-containing device part numbers. Increased minimum CVDD & VDD_PLL voltages from 1.65 V min. to 1.71 V min. Changed operating temperatures to 0 to 60°C commercial, -40 to 70°C industrial.
F2	March 2010	Increased commercial/industrial temperatures to 70/85 deg. C max.

Table of Contents

List of Tables

Universal Asynchronous Receiver/Transmitters (UARTs)

Three 16550-compatible UARTs are supplied. Two provide asynchronous HDLC (High-level Data Link Control) protocol support for full duplex transmit and receive. The HDLC receiver handles framing, address matching, CRC checking, control-octet transparency, and optionally passes the CRC to the host at the end of the packet. The HDLC transmitter handles framing, CRC generation, and control-octet transparency. The host must assemble the frame in memory before transmission. The HDLC receiver and transmitter use the UART FIFOs to buffer the data streams. A third IrDA® compatible UART is also supplied.

- UART1 supports modem bit rates up to 115.2 kbps, supports HDLC and includes a 16 byte FIFO for receive and a 16 byte FIFO for transmit. Interrupts are generated on Rx, Tx and modem status change.
- UART2 contains an IrDA encoder operating at either the slow (up to 115 kbps), medium (0.576 or 1.152 Mbps), or fast (4 Mbps) IR data rates. It also has a 16 byte FIFO for receive and a 16 byte FIFO for transmit.
- UART3 supports HDLC and includes a 16 byte FIFO for receive and a 16 byte FIFO for transmit. Interrupts are generated on Rx and Tx.

Table H. Universal Asynchronous Receiver / Transmitters Pin Assignments

Pin Mnemonic	Pin Name - Description
TXD0	UART1 Transmit
RXD0	UART1 Receive
CTSn	UART1 Clear To Send / Transmit Enable
DSRn/DCDn	UART1 Data Set Ready / Data Carrier Detect
DTRn	UART1 Data Terminal Ready
RTSn	UART1 Ready To Send
EGPIO[0]/RI	UART1 Ring Indicator
TXD1/SIROUT	UART2 Transmit / IrDA Output
RXD1/SIRIN	UART2 Receive / IrDA Input
TXD2	UART3 Transmit
RXD2	UART3 Receive
TENn	HDLC3 Transmit Enable

Internal Boot ROM

The Internal 16-kbyte ROM allows booting from FLASH memory, SPI or UART. Consult the EP9307 User's Guide for operational details.

Triple-port USB Host

The USB Open Host Controller Interface (Open HCI) provides full-speed serial communications ports at a baud rate of 12 Mbits/sec. Up to 127 USB devices (printer, mouse, camera, keyboard, etc.) and USB hubs can be connected to the USB host in the USB "tiered-star" topology.

This includes the following features:

- Compliance with the USB 2.0 specification
- Compliance with the Open HCI Rev 1.0 specification
- Supports both low-speed (1.5 Mbps) and full-speed (12 Mbps) USB device connections
- Root HUB integrated with 3 downstream USB ports
- Transceiver buffers integrated, over-current protection on ports
- Supports power management
- Operates as a master on the bus

The Open HCI host controller initializes the master DMA transfer with the AHB bus:

- Fetches endpoint descriptors and transfer descriptors
- Accesses endpoint data from system memory
- Accesses the HC communication area
- Writes status and retire transfer descriptor

Table I. Triple Port USB Host Pin Assignments

Pin Mnemonic	Pin Name - Description
USBp[2:0]	USB Positive signals
USBm[2:0]	USB Negative Signals

Two-wire Interface Support

The two-wire interface provides communication and control for synchronous-serial-driven devices.

Table J. Two-Wire Port with EEPROM Support Pin Assignments

Pin Mnemonic	Pin Name - Description	Alternative Usage
EECLK	Two-wire Interface Clock	General Purpose I/O
EEDATA	Two-wire Interface Data	General Purpose I/O

Memory Interface

Figure 2 through Figure 5 define the timings associated with all phases of the SDRAM. The following table contains the values for the timings of each of the SDRAM modes.

Parameter	Symbol	Min	Typ	Max	Unit
SDCLK high time	t_{clk_high}	-	$(t_{HCLK}) / 2$	-	ns
SDCLK low time	t_{clk_low}	-	$(t_{HCLK}) / 2$	-	ns
SDCLK rise/fall time	t_{clkrf}	-	2	4	ns
Signal delay from SDCLK rising edge time	t_d	-	-	8	ns
Signal hold from SDCLK rising edge time	t_h	1	-	-	ns
DQMn delay from SDCLK rising edge time	t_{DQd}	-	-	8	ns
DQMn hold from SDCLK rising edge time	t_{DQh}	1	-	-	ns
DA valid setup to SDCLK rising edge time	t_{DAs}	2	-	-	ns
DA valid hold from SDCLK rising edge time	t_{DAh}	3	-	-	ns

SDRAM Load Mode Register Cycle

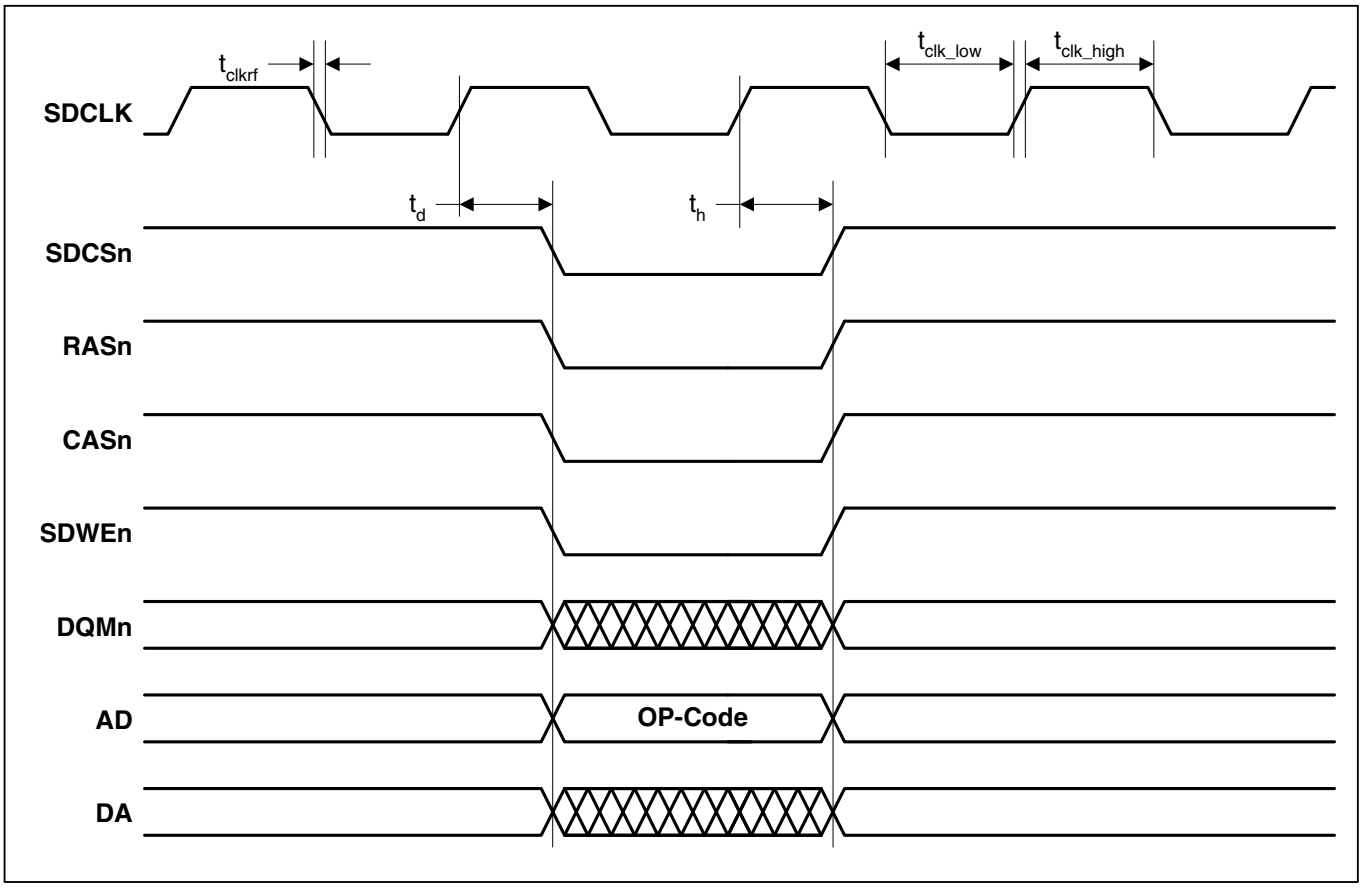


Figure 2. SDRAM Load Mode Register Cycle Timing Measurement

SDRAM Burst Read Cycle

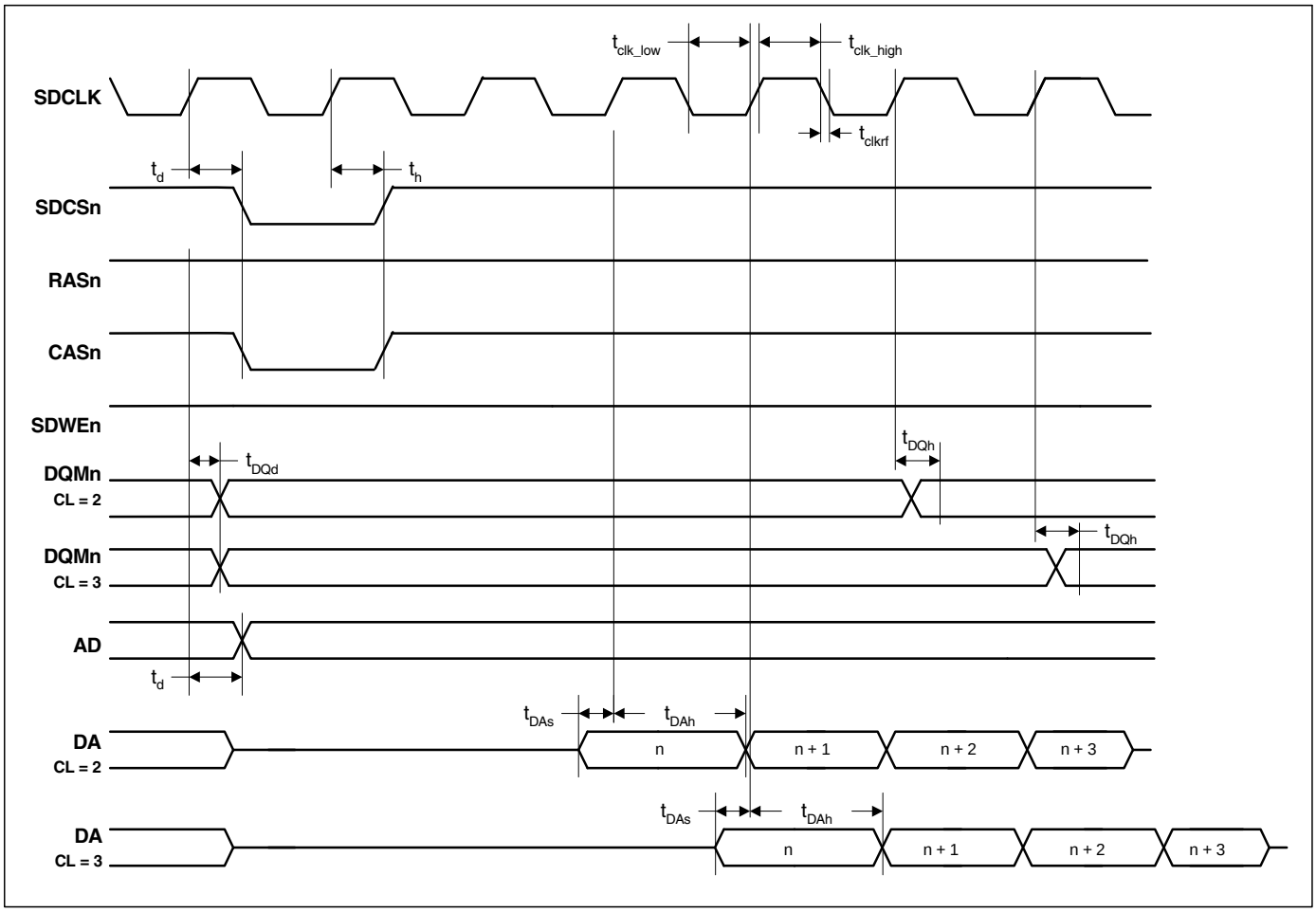
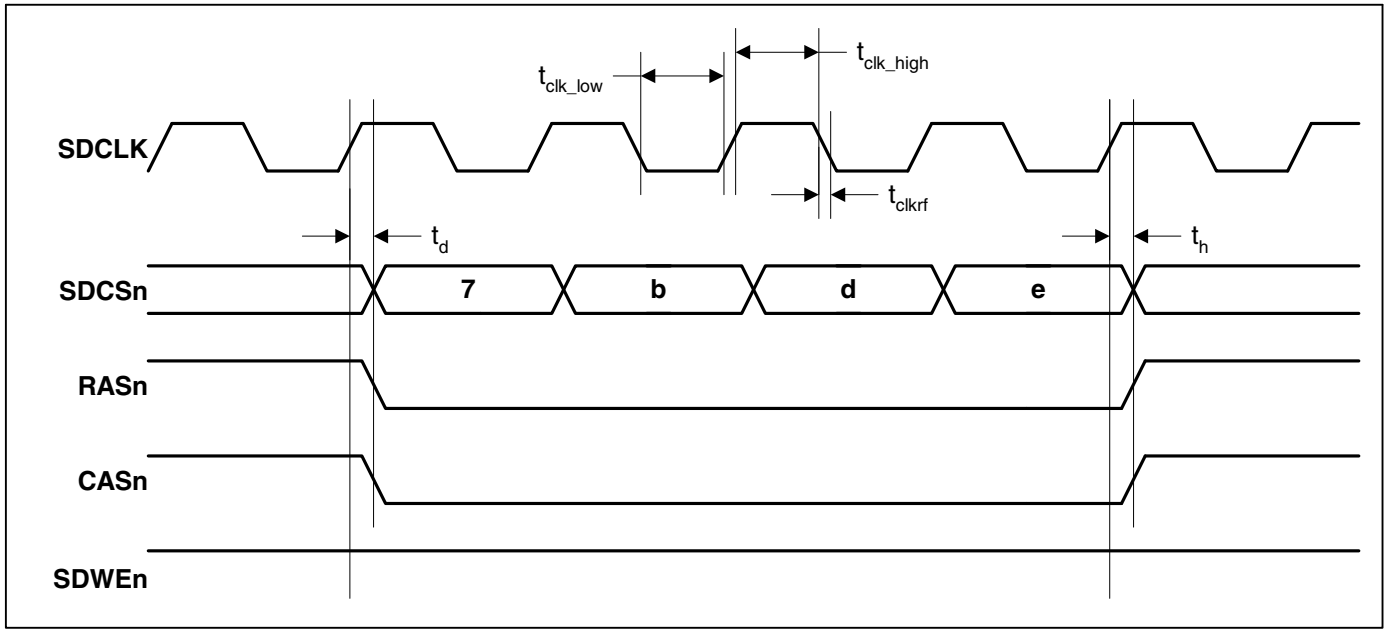


Figure 3. SDRAM Burst Read Cycle Timing Measurement

SDRAM Auto Refresh Cycle



Note: Chip select shown as bus to illustrate multiple devices being put into auto refresh in one access

Figure 5. SDRAM Auto Refresh Cycle Timing Measurement

Static Memory 32-bit Write on 8-bit External Bus

Parameter	Symbol	Min	Typ	Max	Unit
AD setup to WRn assert time	t_{ADs}	$t_{HCLK} - 3$	-	-	ns
WRn/DQMn deassert to AD transition time	t_{ADd}	-	-	$t_{HCLK} + 6$	ns
AD hold from WRn deassert time	t_{ADh}	$t_{HCLK} \times 2$	-	-	ns
CSn hold from WRn deassert time	t_{CSh}	7	-	-	ns
CSn to WRn assert delay time	t_{WRd}	-	-	2	ns
WRn assert time	t_{WRpwL}	-	$t_{HCLK} \times (WST1 + 1)$	-	ns
WRn deassert time	t_{WRpwH}	-	$t_{HCLK} \times 2$	$(t_{HCLK} \times 2) + 14$	ns
CSn to DQMn assert delay time	t_{DQMd}	-	-	1	ns
DQMn assert time	t_{DQMpwL}	-	$t_{HCLK} \times (WST1 + 1)$	-	ns
DQMn deassert time	t_{DQMpwH}	-	-	$(t_{HCLK} \times 2) + 7$	ns
WRn / DQMn deassert to DA transition time	t_{DAh}	t_{HCLK}	-	-	ns
WRn / DQMn assert to DA valid time	t_{DAV}	-	-	8	ns

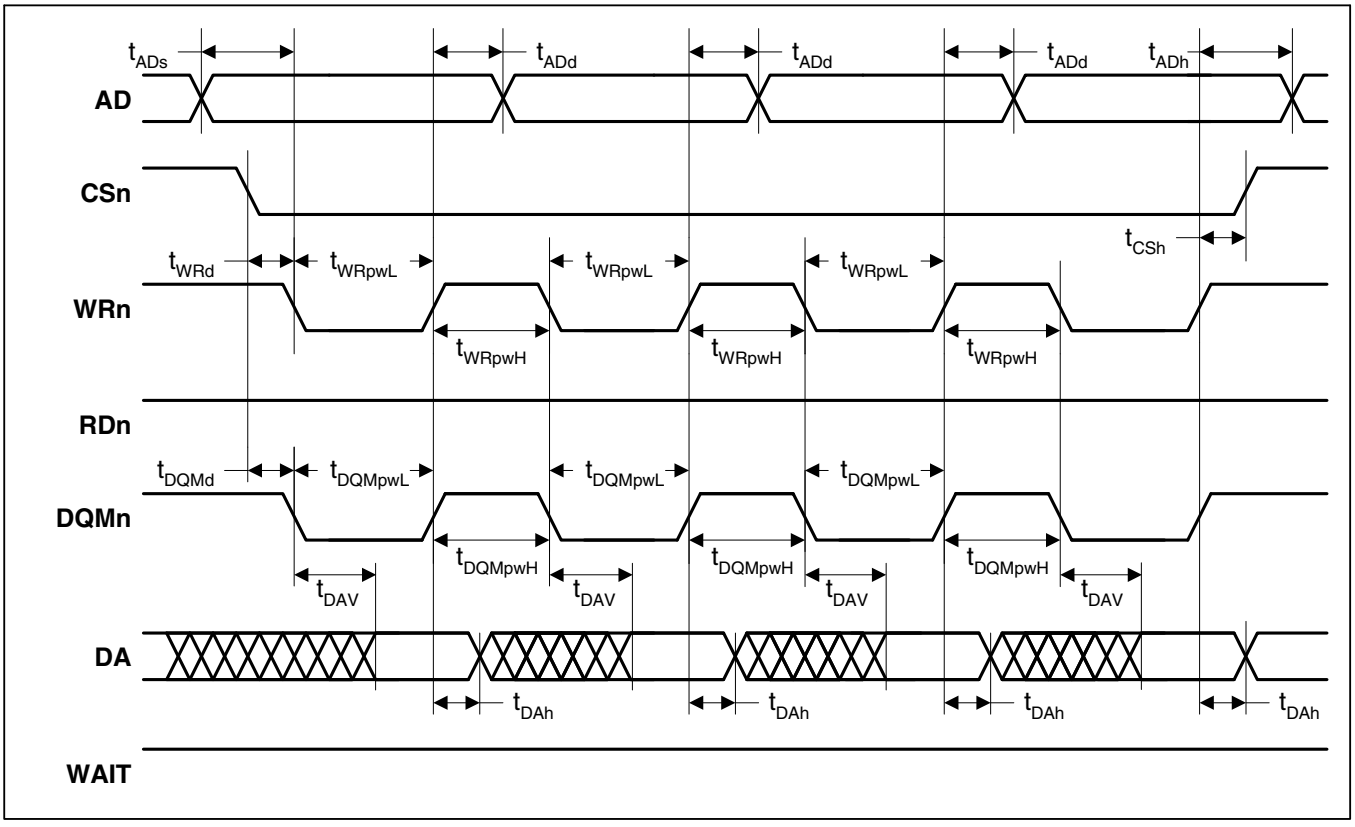


Figure 9. Static Memory Multiple Word Write 8-bit Cycle Timing Measurement

Static Memory 32-bit Read on 16-bit External Bus

Parameter	Symbol	Min	Typ	Max	Unit
AD setup to CSn assert time	t_{ADs}	t_{HCLK}	-	-	ns
CSn assert to AD transition time	t_{ADd1}	-	$t_{HCLK} \times (WST1 + 1)$	-	ns
AD transition to CSn deassert time	t_{ADd2}	-	$t_{HCLK} \times (WST1 + 2)$	-	ns
AD hold from CSn deassert time	t_{ADh}	t_{HCLK}	-	-	ns
RDn assert time	t_{RDpwL}	-	$t_{HCLK} \times ((2 \times WST1) + 3)$	-	ns
CSn to RDn delay time	t_{RDd}	-	-	3	ns
CSn assert to DQMn assert delay time	t_{DQMd}	-	-	1	ns
DA setup to AD transition time	t_{DAs1}	15	-	-	ns
DA to RDn deassert time	t_{DAs2}	t_{HCLK} + 12	-	-	ns
DA hold from AD transition time	t_{DAh1}	0	-	-	ns
DA hold from RDn deassert time	t_{DAh2}	0	-	-	ns

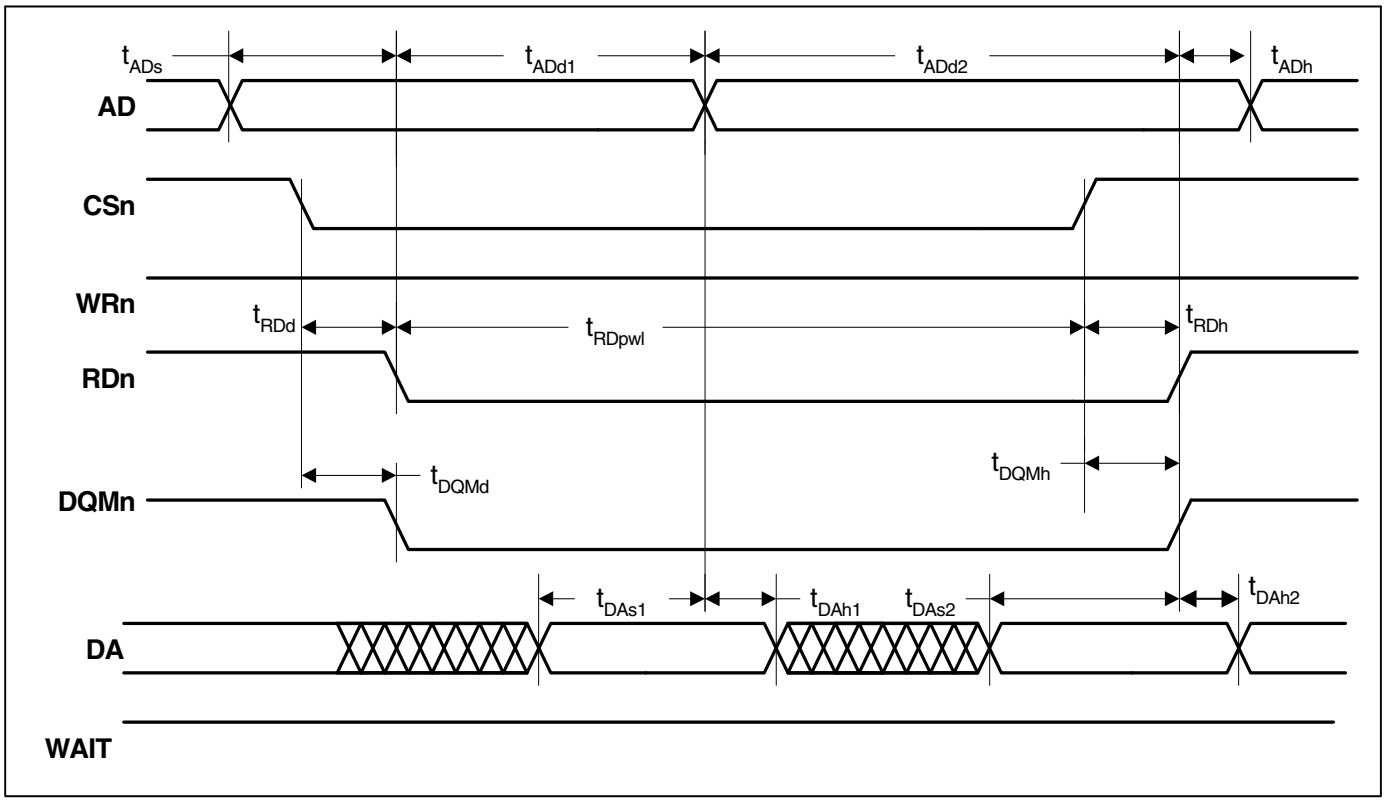


Figure 10. Static Memory Multiple Word Read 16-bit Cycle Timing Measurement

Static Memory Burst Write Cycle

Parameter	Symbol	Min	Typ	Max	Unit
AD setup to WRn assert time	t_{ADs}	$t_{HCLK} - 3$			ns
AD hold from WRn deassert time	t_{ADh}	$t_{HCLK} \times 2$			ns
WRN/DQMn deassert to AD transition time	t_{ADd}			$t_{HCLK} + 6$	ns
CSn hold from WRn deassert time	t_{CSh}	7			ns
CSn to WRn assert delay time	t_{WRd}			2	ns
CSn to DQMn assert delay time	t_{DQMd}			1	ns
DQMn assert time	t_{DQpwL}		$t_{HCLK} \times (WST1 + 1)$		ns
DQMn deassert time	t_{DQpwH}			$(t_{HCLK} \times 2) + 14$	ns
WRn assert time	t_{WRpwL}		$t_{HCLK} \times (WST1 + 11)$		ns
WRn deassert time	t_{WRpwH}			$(t_{HCLK} \times 2) + 7$	ns
WRn/DQMn deassert to DA transition time	t_{DAh}	t_{HCLK}			ns
WRn/DQMn assert to DA valid time	t_{DAv}			8	ns

Note: These characteristics are valid when the Page Mode Enable (Burst Mode) bit is set. See the User's Guide for details.

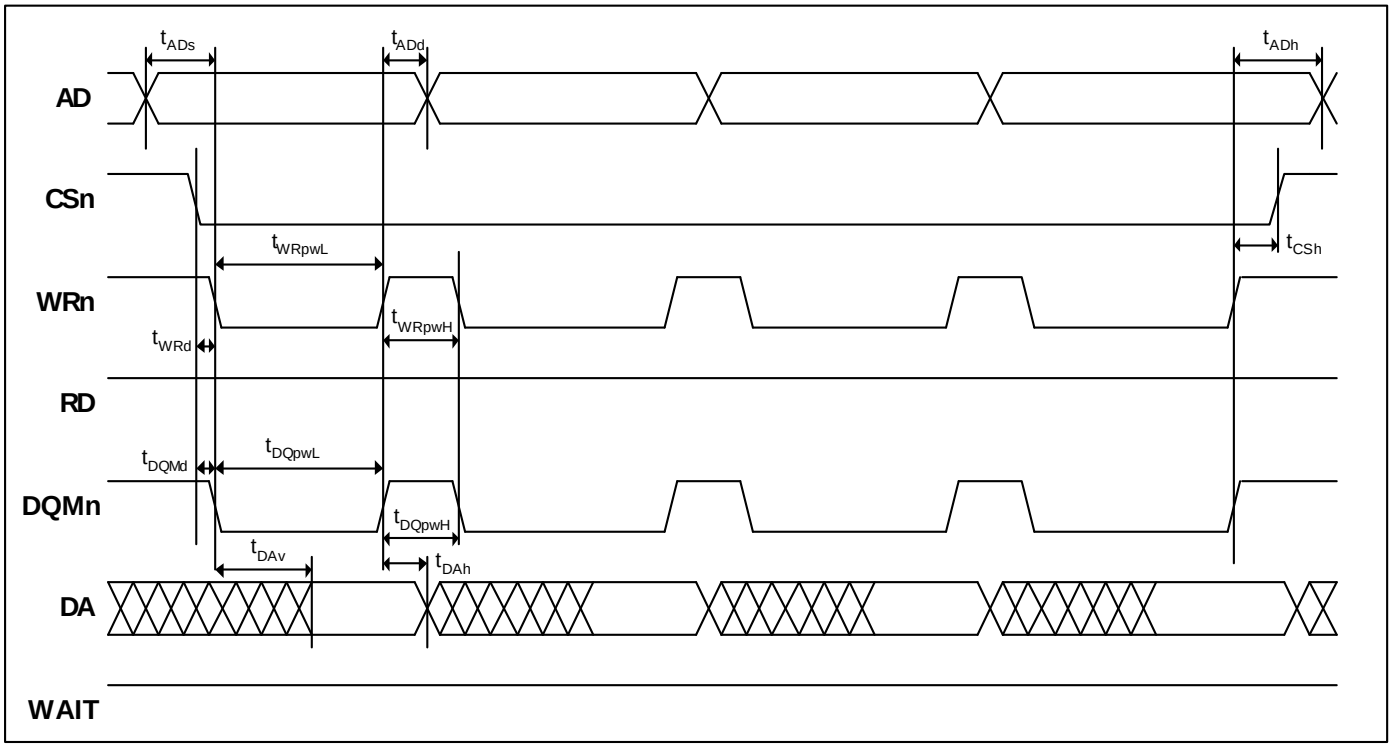


Figure 13. Static Memory Burst Write Cycle Timing Measurement

Static Memory Single Write Wait Cycle

Parameter	Symbol	Min	Typ	Max	Unit
WAIT to WRn deassert delay time	t_{WRd}	$t_{HCLK} \times 2$	-	$t_{HCLK} \times 4$	ns
CSn assert to WAIT time	t_{WAITd}	-	-	$t_{HCLK} \times$ (WST1-2)	ns
WAIT assert time	t_{WAITpw}	$t_{HCLK} \times 2$	-	$t_{HCLK} \times 510$	ns
WAIT to CSn deassert delay time	t_{CSnd}	$t_{HCLK} \times 3$	-	$t_{HCLK} \times 5$	ns

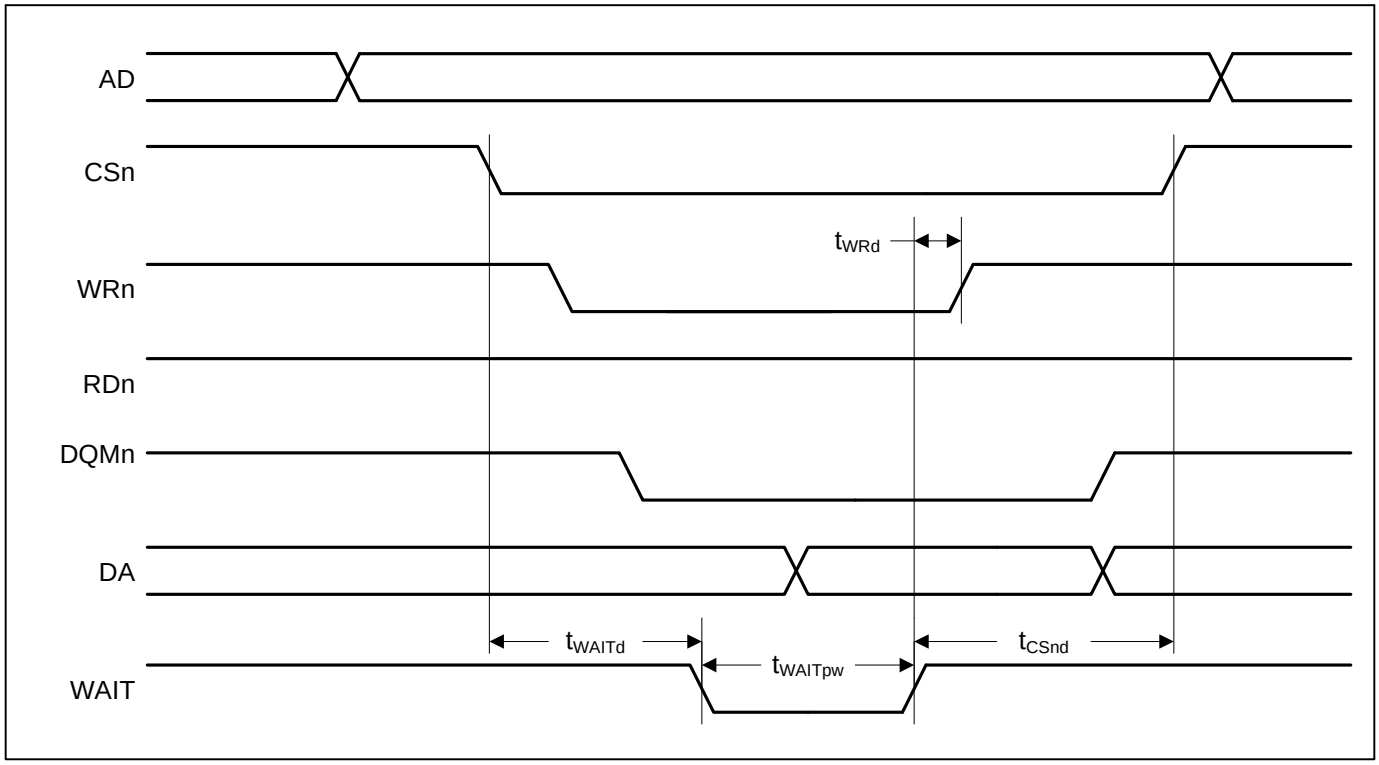


Figure 15. Static Memory Single Write Wait Cycle Timing Measurement

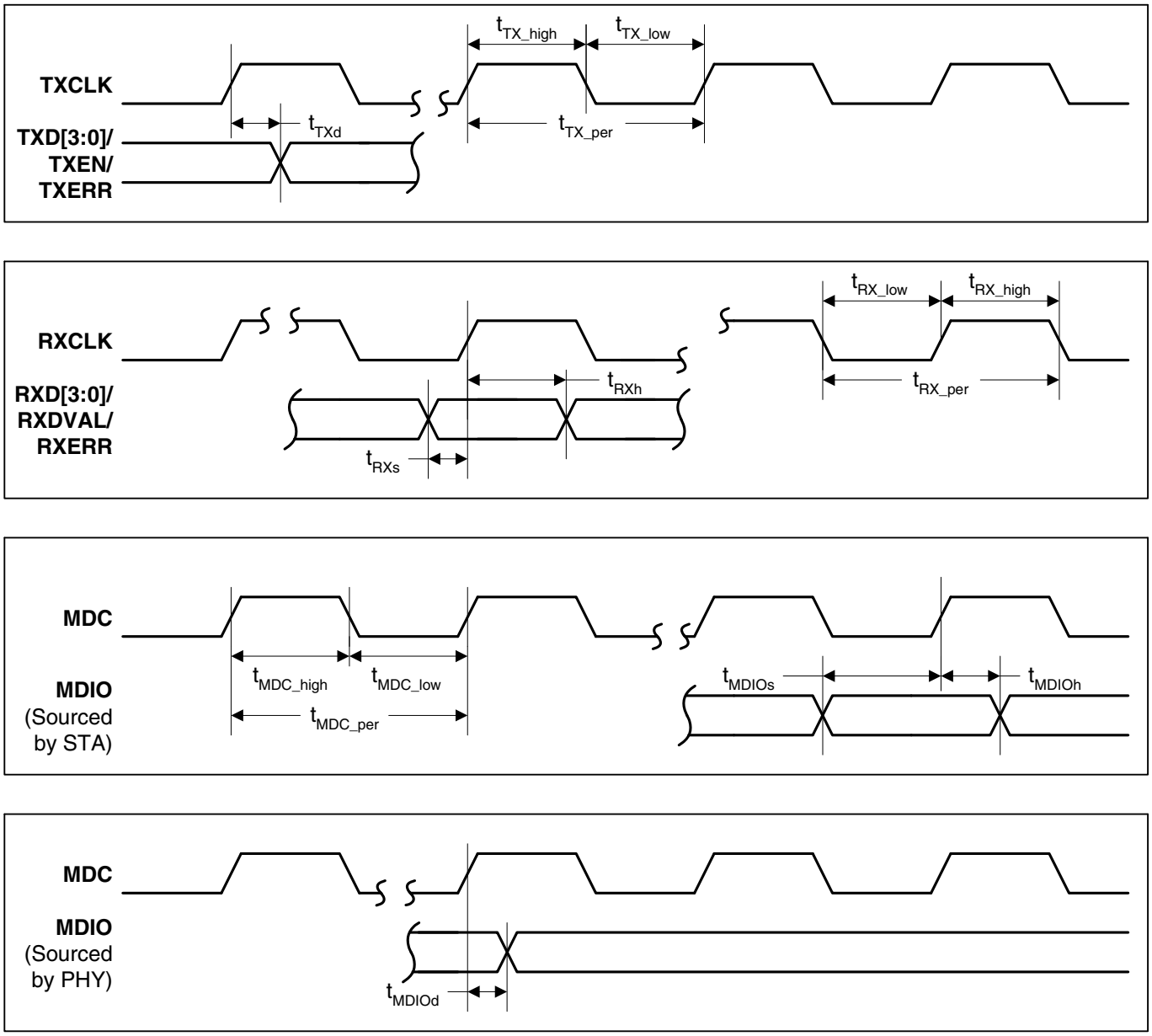


Figure 17. Ethernet MAC Timing Measurement

Audio Interface

The following table contains the values for the timings of each of the SPI modes.

Parameter	Symbol	Min	Typ	Max	Unit
SCLK cycle time	t_{clk_per}	-	tspix_clk	-	ns
SCLK high time	t_{clk_high}	-	(tspix_clk) / 2	-	ns
SCLK low time	t_{clk_low}	-	(tspix_clk) / 2	-	ns
SCLK rise/fall time	t_{clkrf}	1	-	8	ns
Data from master valid delay time	t_{DMd}	-	-	3	ns
Data from master setup time	t_{DMs}	20	-	-	ns
Data from master hold time	t_{DMh}	40	-	-	ns
Data from slave setup time	t_{DSs}	20	-	-	ns
Data from slave hold time	t_{DSh}	40	-	-	ns

Note: The tspix_clk is programmable by the user.

Texas Instruments' Synchronous Serial Format

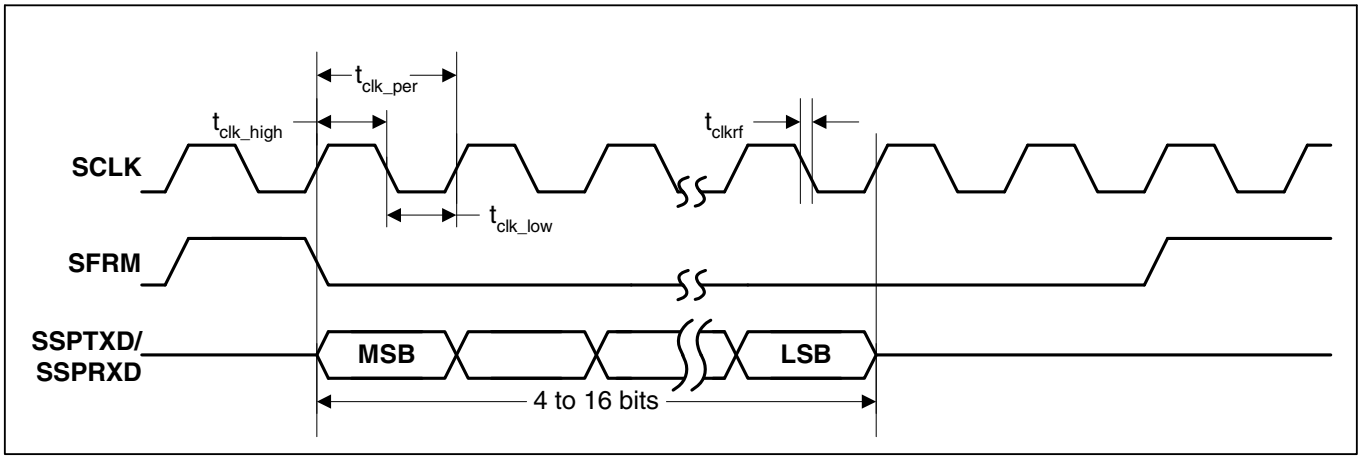


Figure 18. *TI* Single Transfer Timing Measurement

Microwire

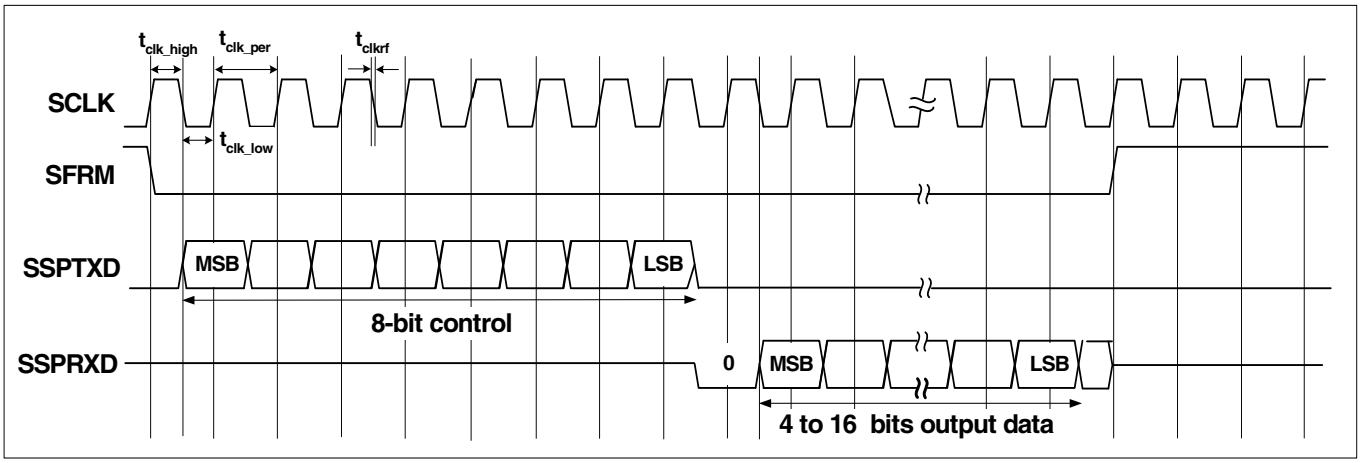


Figure 19. Microwire Frame Format, Single Transfer

Inter-IC Sound - I²S

Parameter	Symbol	Min	Typ	Max	Unit
SCLK cycle time	t_{clk_per}	-	t_{i2s_clk}	-	ns
SCLK high time	t_{clk_high}	-	$(t_{i2s\_clk}) / 2$	-	ns
SCLK low time	t_{clk_low}	-	$(t_{i2s\_clk}) / 2$	-	ns
SCLK rise/fall time	t_{clkrf}	1	4	8	ns
SCLK to LRCLK assert delay time	t_{LRd}	-	-	3	ns
Hold between SCLK assert then LRCLK deassert *or* Hold between LRCLK deassert then SCLK assert	t_{LRh}	0	-	-	ns
SDI to SCLK deassert setup time	t_{SDIs}	12	-	-	ns
SDI from SCLK deassert hold time	t_{SDIh}	0	-	-	ns
SCLK assert to SDO delay time	t_{SDOd}	-	-	9	ns
SDO from SCLK assert hold time	t_{SDOh}	1	-	-	ns

Note: t_{i2s_clk} is programmable by the user.

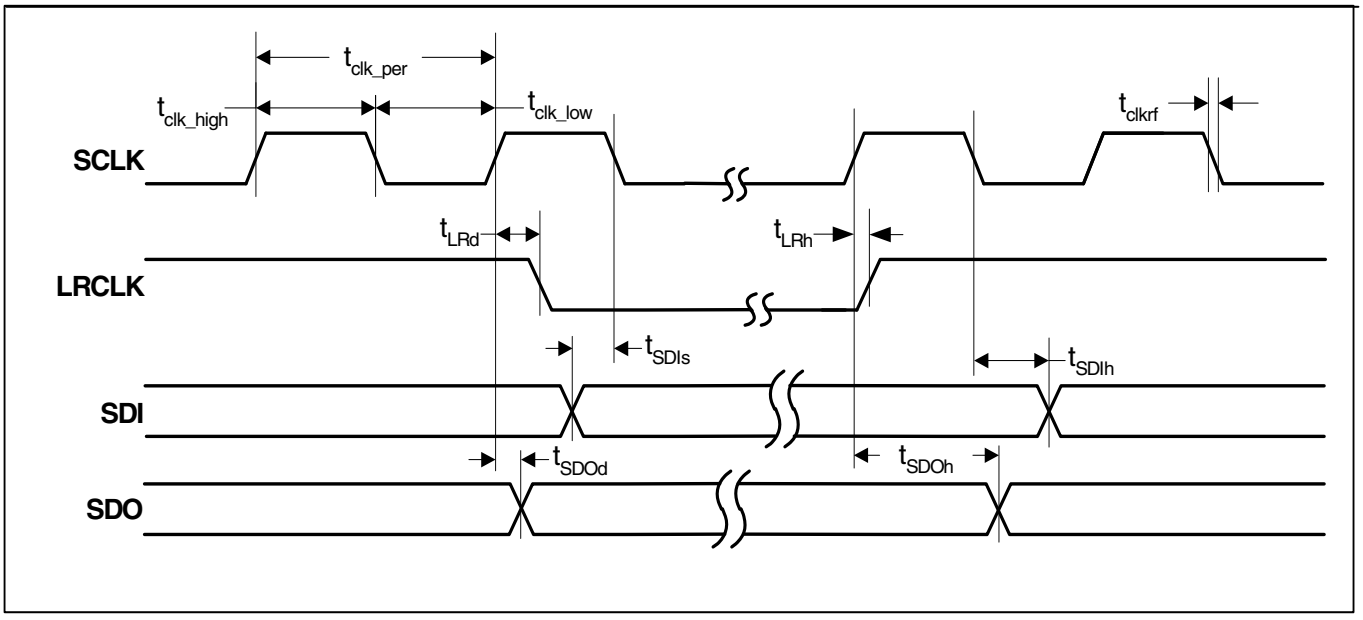
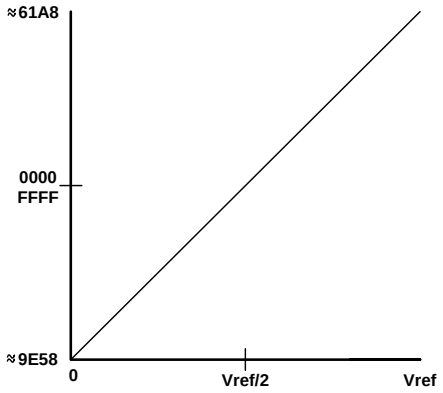


Figure 21. Inter-IC Sound (I^2S) Timing Measurement

ADC

Parameter	Comment	Value	Units
Resolution	No missing codes Range of 0 to 3.3 V	50K counts (approximate)	
Integral non-linearity		0.01%	
Offset error		±15	mV
Full scale error		0.2%	
Maximum sample rate	ADIV = 0 ADIV = 1	3750 925	Samples per second Samples per second
Channel switch settling time	ADIV = 0 ADIV = 1	500 2	µs ms
Noise (RMS) - typical		120	µV

Note: ADIV refers to bit 16 in the KeyTchClkDiv register.
ADIV = 0 means the input clock to the ADC module is equal to the external 14.7456 MHz clock divided by 4.
ADIV = 1 means the input clock to the ADC module is equal to the external 14.7456 MHz clock divided by 16.



A/D Converter Transfer Function
(approximately ±25,000 counts)

Figure 24. ADC Transfer Function

Using the ADC:

This ADC has a state-machine based conversion engine that automates the conversion process. The initiator for a conversion is the read access of the TSXYResult register by the CPU. The data returned from reading this register contains the result as well as the status bit indicating the state of the ADC. However, this peripheral requires a delay between each successful conversion and the issue of the next conversion command, or else the returned value of successive samples may not reflect the analog input. Since the state of the ADC state machine is returned through the same channel used to initiate the conversion process, there must be a delay inserted after every complete conversion. Note that reading TSXYResult during a conversion will not affect the result of the ongoing process.

The following is a recommended procedure for safely polling the ADC from software:

1. Read the TSXYResult register into a local variable to initiate a conversion.
2. If the value of bit 31 of the local variable is '0' then repeat step 1.
3. Delay long enough to meet the maximum sample rate as shown above.
4. Mask the local variable with 0xFFFF to remove extraneous data.
5. If signed mode is used, do a sign extend of the lower halfword.
6. Return the sampled value.

Pin List

The following Thin-profile Fine-pitch Ball Grid Array (TFBGA) ball assignment table is sorted in order of ball.

Ball	Signal	Ball	Signal	Ball	Signal	Ball	Signal
A1	CSn[1]	E1	SDCSn[2]	J10	gndc	P1	SPCLK
A2	CSn[7]	E2	SDWEN	J12	vddc	P2	P[10]
A3	SDCLKEN	E3	DA[22]	J13	vddr	P3	P[11]
A4	DA[31]	E4	AD[3]	J14	COL[5]	P4	P[3]
A5	DA[29]	E5	DA[15]	J15	COL[6]	P5	AD[15]
A6	DA[27]	E6	AD[21]	J16	CSn[0]	P6	AD[13]
A7	HGPIO[2]	E7	DA[17]	J17	COL[3]	P7	AD[12]
A8	RDn	E8	vddr	K1	AD[4]	P8	DA[2]
A9	MIIRXD[3]	E9	vddr	K2	DA[12]	P9	AD[8]
A10	RXDVAL	E10	vddr	K3	DA[10]	P10	TCK
A11	MIITXD[1]	E11	MIIRXD[0]	K4	DA[11]	P11	BOOT[1]
A12	CRS	E12	TXERR	K5	vddr	P12	EEDAT
A13	FGPIO[7]	E13	EGPIO[2]	K6	gndr	P13	GRLED
A14	FGPIO[0]	E14	EGPIO[4]	K8	gndc	P14	RDLED
A15	WAITn	E15	EGPIO[3]	K9	gndc	P15	GGPIO[2]
A16	USBm[2]	E16	sXp	K10	gndc	P16	RXD[1]
A17	ASDI	E17	sXm	K12	vddc	P17	RXD[2]
B1	AD[25]	F1	RASn	K13	COL[4]	R1	P[9]
B2	CSn[2]	F2	SDCSn[1]	K14	PLL_VDD	R2	HSYNC
B3	CSn[6]	F3	SDCSn[0]	K15	COL[2]	R3	P[6]
B4	AD[20]	F4	DQMn[3]	K16	COL[1]	R4	P[5]
B5	DA[30]	F5	AD[5]	K17	COL[0]	R5	P[0]
B6	AD[18]	F6	gndr	L1	DA[9]	R6	AD[14]
B7	HGPIO[3]	F7	gndr	L2	AD[2]	R7	DA[4]
B8	AD[17]	F8	gndr	L3	AD[1]	R8	DA[1]
B9	RXCLK	F9	vddc	L4	DA[8]	R9	DTRn
B10	MIIRXD[1]	F10	vddc	L5	BLANK	R10	TDI
B11	MIITXD[2]	F11	gndr	L6	gndr	R11	BOOT[0]
B12	TXEN	F12	EGPIO[7]	L12	gndr	R12	ASYNC
B13	FGPIO[5]	F13	EGPIO[5]	L13	ROW[7]	R13	SSPTX[1]
B14	EGPIO[15]	F14	ADC_GND	L14	ROW[5]	R14	PWMOUT
B15	USBp[2]	F15	EGPIO[6]	L15	PLL_GND	R15	USBm[0]
B16	ARSTn	F16	sYm	L16	XTALI	R16	ABITCLK
B17	ADC_VDD	F17	sYp	L17	XTALO	R17	USBp[0]
C1	AD[23]	G1	DQMn[0]	M1	BRIGHT	T1	NC
C2	DA[26]	G2	CASn	M2	AD[0]	T2	NC
C3	CSn[3]	G3	DA[21]	M3	DQMn[1]	T3	V_CSYNC
C4	DA[25]	G4	AD[22]	M4	DQMn[2]	T4	P[7]
C5	AD[24]	G5	vddr	M5	P[17]	T5	P[2]
C6	AD[19]	G6	gndr	M6	gndr	T6	DA[7]
C7	HGPIO[5]	G12	gndr	M7	gndr	T7	AD[11]
C8	WRn	G13	EGPIO[9]	M8	vddc	T8	AD[9]

Table T illustrates the pin signal multiplexing and configuration options.

Table T. Pin Multiplex Usage Information

Physical Pin Name	Description	Multiplex signal name
COL[7:0]	GPIO	GPIO Port D[7:0]
ROW[7:0]	GPIO	GPIO Port C[7:0]
EGPIO[0]	Ring Indicator Input	RI
EGPIO[1]	1Hz clock monitor	CLK1HZ
EGPIO[2]	DMA request	DMARQ
EGPIO[3]	HDLC Clock	HDLCCLK1
EGPIO[4]	I2S Transmit Data 1	SDO1
EGPIO[5]	I2S Receive Data 1	SDI1
EGPIO[6]	I2S Transmit Data 2	SDO2
EGPIO[7]	DMA Request 0	DREQ0
EGPIO[8]	DMA Acknowledge 0	DACK0
EGPIO[9]	DMA EOT 0	DEOT0
EGPIO[10]	DMA Request 1	DREQ1
EGPIO[11]	DMA Acknowledge 1	DACK1
EGPIO[12]	DMA EOT 1	DEOT1
EGPIO[13]	I2S Receive Data 2	SDI2
EGPIO[15]	Device active / present	DASP
ABITCLK	I2S Serial clock	SCLK
ASYNC	I2S Frame Clock	LRCK
ASDO	I2S Transmit Data 0	SDO0
ASDI	I2S Receive Data 0	SDI0
ARSTn	I2S Master clock	MCLK
SCLK1	I2S Serial clock	SCLK
SFRM1	I2S Frame Clock	LRCK
SSPTX1	I2S Transmit Data 0	SDO0
SSPRX1	I2S Receive Data 0	SDI0

Acronyms and Abbreviations

The following tables list abbreviations and acronyms used in this data sheet.

Term	Definition
ADC	Analog-to-Digital Converter
ALT	Alternative
AMBA	Advanced Micro-controller Bus Architecture
ATAPI	ATA Packet Interface
CODEC	COder / DECoder
CRC	Cyclic Redundancy Check
DAC	Digital-to-Analog Converter
DMA	Direct-Memory Access
EBUS	External Memory Bus
EEPROM	Electronically Erasable Programmable Read Only Memory
EMAC	Ethernet Media Access Controller
FIFO	First In / First Out
FIQ	Fast Interrupt Request
FLASH	Flash memory
GPIO	General Purpose I/O
HDLC	High-level Data Link Control
I/F	Interface
I^2S	Inter-IC Sound
IC	Integrated Circuit
ICE	In-Circuit Emulator
IDE	Integrated Drive Electronics
IEEE	Institute of Electronics and Electrical Engineers
IrDA	Infrared Data Association
IRQ	Standard Interrupt Request
ISO	International Standards Organization
JTAG	Joint Test Action Group
LFSR	Linear Feedback Shift Register
MII	Media Independent Interface
MMU	Memory Management Unit
OHCI	Open Host Controller Interface
PHY	Ethernet PHYsical layer interface
PIO	Programmed I/O
RISC	Reduced Instruction Set Computer
SDMI	Secure Digital Music Initiative
SDRAM	Synchronous Dynamic RAM
SPI	Serial Peripheral Interface
SRAM	Static Random Access Memory
STA	Station - Any device that contains an IEEE 802.11 conforming Medium Access Control (MAC) and physical layer (PHY) interface to the wireless medium
TFT	Thin Film Transistor
TLB	Translation Lookaside Buffer
USB	Universal Serial Bus

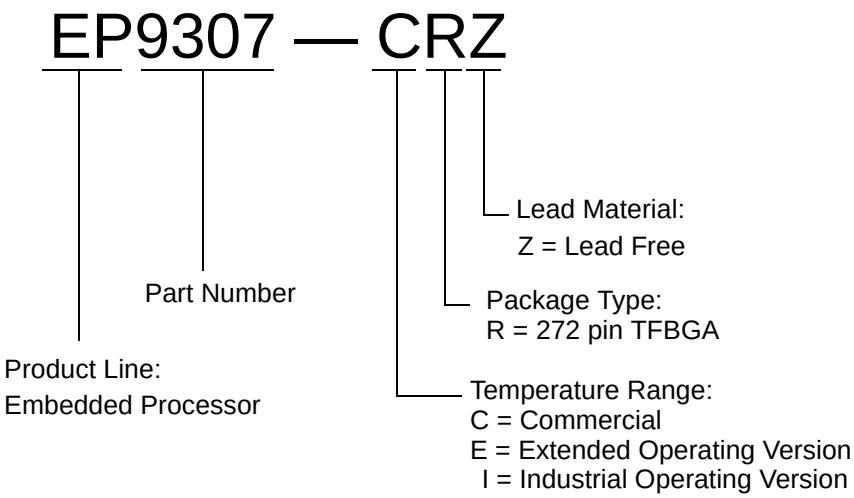
Units of Measurement

Symbol	Unit of Measure
^{o}C	degree Celsius
Hz	Hertz = cycle per second
Kbps	Kilobits per second
kbyte	Kilobyte
kHz	KiloHertz = 1000 Hz
Mbps	Megabits per second
MHz	MegaHertz = 1,000 kHz
µA	microAmpere = 10^{-6} Ampere
µs	microsecond = 1,000 nanoseconds = 10^{-6} seconds
mA	milliAmpere = 10^{-3} Ampere
ms	millisecond = 1,000 microseconds = 10^{-3} seconds
mW	milliWatt = 10^{-3} Watts
ns	nanosecond = 10^{-9} seconds
pF	picoFarad = 10^{-12} Farads
V	Volt
W	Watt

ORDERING INFORMATION

The order numbers for the device are:

EP9307-CRZ	0°C to +70°C	272 pin TFBGA	Lead Free
EP9307-IRZ	-40°C to +85°C	272 pin TFBGA	Lead Free



Note: Go to the Cirrus Logic Internet site at http://www.cirrus.com to find contact information for your local sales representative.